

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT3371036

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
VLADIMIR A. UKRAINTSEV	05/20/2014
RICHARD STALLCUP	06/23/2014
SERGIY PRYADKIN	06/19/2014
MIKE BERKMYRE	06/23/2014
JOHN SANDERS	05/20/2014
RECEIVING PARTY DATA	
Name:	DCG SYSTEMS, INC.
Street Address:	3400 W. WARREN AVENUE
City:	FREMONT
State/Country:	CALIFORNIA
Postal Code:	94538
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14552399
CORRESPONDENCE DATA	
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Correspondent Name:	CHRISTOPHER M. MOONEY
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ATTORNEY DOCKET NUMBER:	049259-130100
NAME OF SUBMITTER:	CHRISTOPHER M. MOONEY
SIGNATURE:	/Christopher M. Mooney/
DATE SIGNED:	05/27/2015
Total Attachments: 7	
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ASSIGNMENT

WHEREAS, the undersigned, **Vladimir A. Ukraintsev**, a resident of Allen, Texas; **Richard Stallcup**, a resident of Frisco, Texas; **Sergiy Pryadkin**, a resident of Plano, Texas; **Mike Berkmyre**, a resident of Allen, Texas; and **John Sanders**, a resident of Coppell, Texas (collectively hereinafter termed "Inventors"), have jointly invented certain new and useful improvements in *System And Method For Non-Contact Microscopy For Three-Dimensional Pre-Characterization Of A Sample For Fast And Non-Destructive On Sample Navigation During Nanoprobing* for which invention we have executed a United States Application having Serial Number 14/083,438, and Filing date November 18, 2013 and which invention is fully described in the specification pertaining to said application.

WHEREAS, **DCG SYSTEMS, INC.** (hereinafter termed "Assignee"), a body having corporate powers under the laws in Delaware, having a place of business at 3400 W. Warren Ave. Fremont CA 94538 U.S.A., is desirous of acquiring the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly or severally by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventors to have been received in full from said Assignee:

I. Said Inventors do hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest (a) in and to said application and said invention, and any later filed United States utility or foreign applications claiming priority to said application; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a priority application, utility, division, substitution, or continuation of any of said applications; and (d) in and to each and every reissue or extension of any of said patents; and (e) all claims for damages by reason of past infringement of said patents, with the right to sue for

and collect the same for its own use and enjoyment, and for use and enjoyment of its successors, assigns or other legal representatives.

2. Said Inventors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting utility, substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefore and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor in providing such cooperation shall be paid for by said Assignee.

3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor, his respective heirs, legal representatives and assigns.

4. Said Inventors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

5. Said Inventors hereby grant(s) the firm of Nixon Peabody LLP, 2 Palo Alto Square, 3000 El Camino Real, Suite 500, Palo Alto, CA 94306 the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

[ASSIGNMENT CONTINUATION]

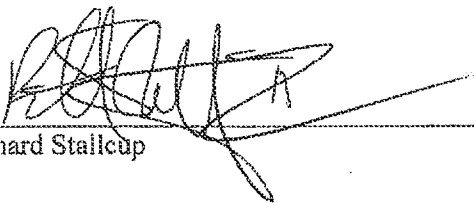
Re: U.S. Patent Application entitled: System And Method For Non-Contact Microscopy For
Three-Dimensional Pre-Characterization Of A Sample For Fast And Non-Destructive On
Sample Navigation During Nanoprobing
Inventor: Vladimir A. Ukraintsev

Vladimir A. Ukraintsev
Vladimir A. Ukraintsev

5/20/2014
(date)

[ASSIGNMENT CONTINUATION]

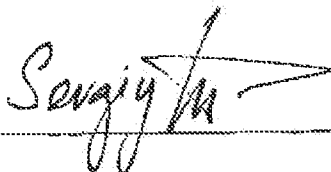
Re: U.S. Patent Application entitled: **System And Method For Non-Contact Microscopy For Three-Dimensional Pre-Characterization Of A Sample For Fast And Non-Destructive On Sample Navigation During Nanoprobing**
Inventor: Richard Stallcup


Richard Stallcup

6/23/2014
(date)

[ASSIGNMENT CONTINUATION]

Re: U.S. Patent Application entitled: System And Method For Non-Contact Microscopy For Three-Dimensional Pre-Characterization Of A Sample For Fast And Non-Destructive On Sample Navigation During Nanoprobng
Inventor: Sergiy Pryadkin

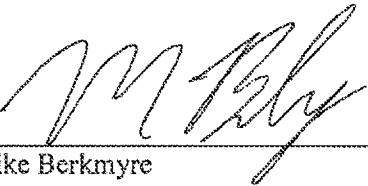
 06/19/2014

Sergiy Pryadkin (date)


[ASSIGNMENT CONTINUATION]

Re: U.S. Patent Application entitled: System And Method For Non-Contact Microscopy For Three-Dimensional Pre-Characterization Of A Sample For Fast And Non-Destructive On Sample Navigation During Nanoprobing

Inventor: Mike Berkmyre



Mike Berkmyre



(date)

[ASSIGNMENT CONTINUATION]

Re: U.S. Patent Application entitled: System And Method For Non-Contact Microscopy For
Three-Dimensional Pre-Characterization Of A Sample For Fast And Non-Destructive On
Sample Navigation During Nanoprobing

Inventor: John Sanders

 5/20/2014
John Sanders (date)